

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE01P13 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

General Features

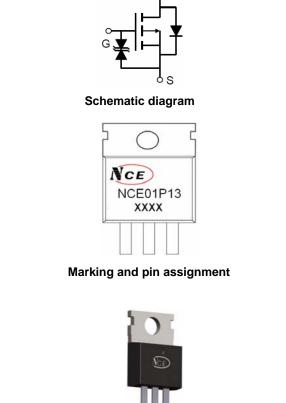
- V_{DS} =-100V,I_D =-13A
 R_{DS(ON)} <200mΩ @ V_{GS}=-10V (Typ:170mΩ)
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density celldesign for ultra low on-resistance

Application

- Power switch
- DC/DC converters

100% UIS TESTED!

100% ΔVds TESTED!



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TO-220-3L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01P13	NCE01P13	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25[°]Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	-13	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	-9.2	А
Pulsed Drain Current	I _{DM}	-52	А
Maximum Power Dissipation	PD	40	W
Derating factor		0.32	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	110	mJ
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 150	°C





Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{θJc}	3.13	°C/W	1
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Electrical Characteristics (T_c=25 $^{\circ}$ Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-100	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±10	μA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250µA	-1	-1.9	-3	V	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-16A	-	170	200	mΩ	
Forward Transconductance	g fs	V _{DS} =-15V,I _D =-5A	12	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}		-	760	-	PF	
Output Capacitance	Coss	V_{DS} =-25V, V_{GS} =0V,	-	260	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	170	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	14	-	nS	
Turn-on Rise Time	tr	V _{DD} =-50V,I _D =-10A	-	18	-	nS	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _{GEN} =9.1Ω	-	50	-	nS	
Turn-Off Fall Time	t _f		-	18	-	nS	
Total Gate Charge	Qg		-	25	-	nC	
Gate-Source Charge	Q _{gs}	V _{DS} =-50V,I _D =-10A, V _{GS} =-10V	-	5	-	nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	7	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-10A	-	-	-1.2	V	
Diode Forward Current (Note 2)	Is	-	-	-	-13	А	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-10A	-	35	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	46	-	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)					

Notes:

- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ C$,V_DD=-50V,VG=-10V,L=0.5mH,Rg=25 Ω

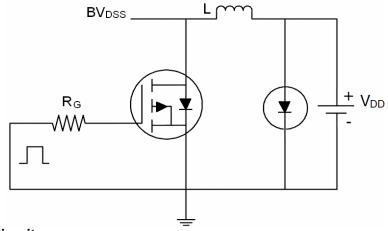


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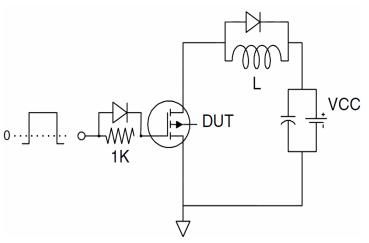




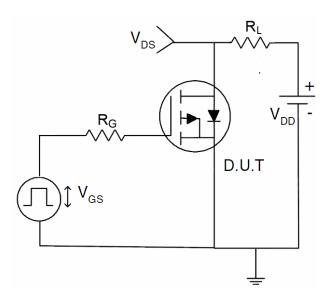
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



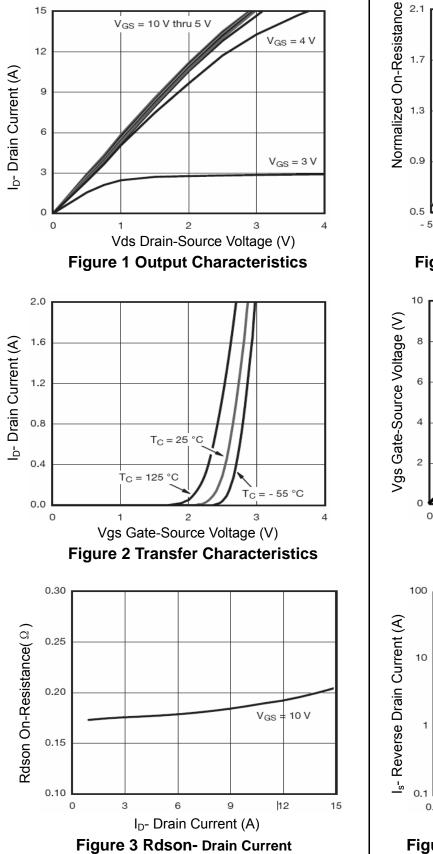
3) Switch Time Test Circuit

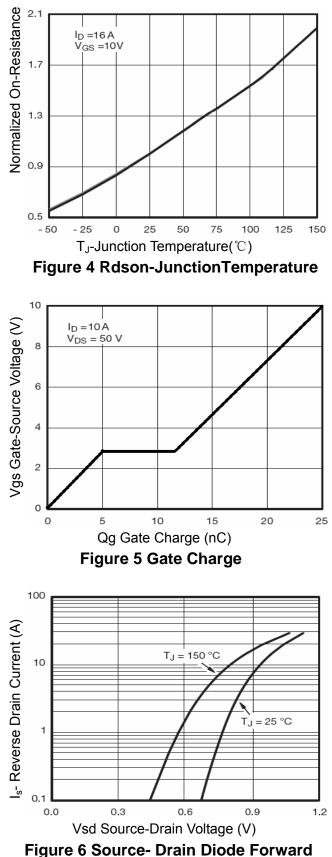






Typical Electrical and Thermal Characteristics (Curves)



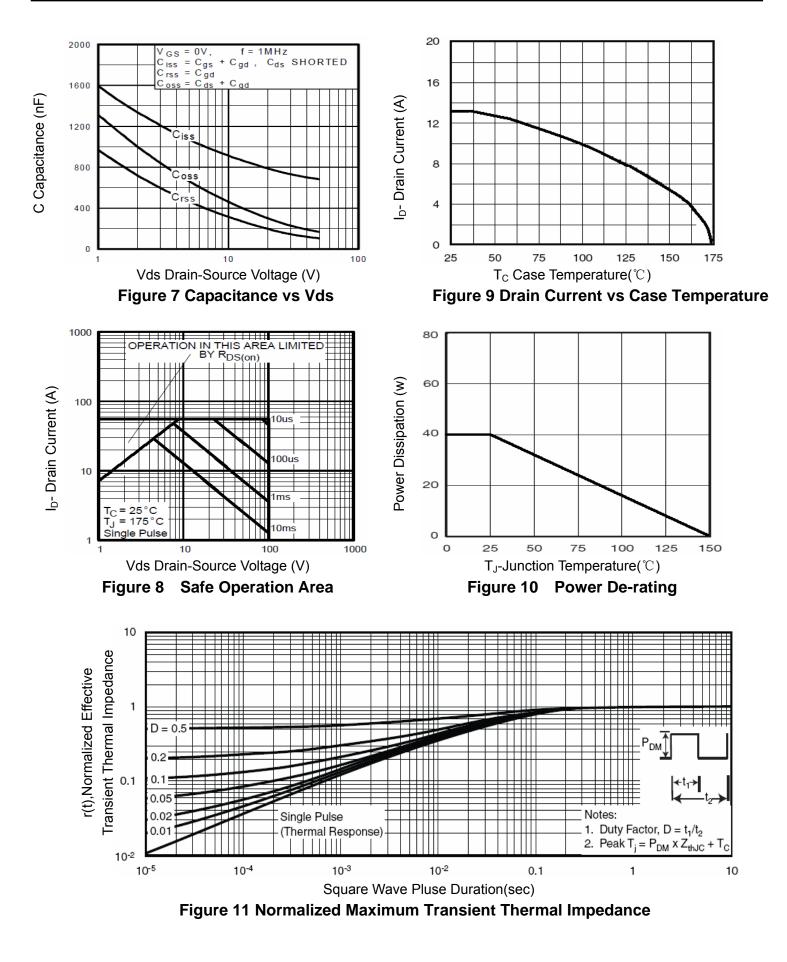




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Pb Free Product

NCE01P13



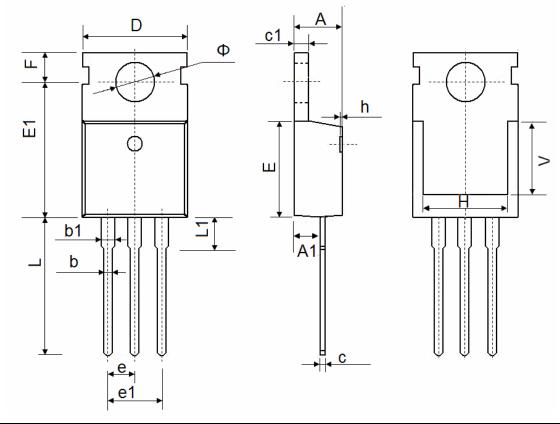


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NCE01P13

TO-220-3L Package Information



Symphol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540) TYP.	0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295	REF.	
Φ	3.400	3.800	0.134	0.150	





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